BGA Heat Sink - High Performance Straight Fin w/maxiGRIP





ATS Part#: ATS-53230K-C1-R0

Description: 23.00 x 23.00 x 14.50 mm BGA Heat Sink - High Performance Straight Fin

w/maxiGRIP

Heat Sink Type: Straight Fin
Heat Sink Attachment: maxiGRIP

Equivalent Part Number: ATS-53230K-C2-R0 Discontinued

*Image above is for illustration purpose only.

Features & Benefits

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB
- Designed specifically for BGAs and other surface mount packages
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock Testing and Unpackaged Drop Testing standards
- Comes preassembled with high performance, phase changing, thermal interface material

Thermal Performance

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	8.8 °C/W	6.7 °C/W	5.7 °C/W	5.1 °C/W	4.7 °C/W	4.3 °C/W	4.1 °C/W
	Ducted Flow	4.9	N/A	N/A	N/A	N/A	N/A	N/A

Product Detail



